

2874



Electronic Filing System (EFS) Data  
Electronic Patent Application Submission  
USPTO Use Only

EFS ID: 26851  
Application ID: 09896695  
Title of Invention: METHOD AND APPARATUS FOR  
PUSH BUTTON RELEASE FIBER  
OPTIC MODULES  
First Named Inventor: Liew Chu  
Domestic/Foreign Application: Domestic Application  
Filing Date: 2001-06-28  
Effective Receipt Date: 2003-05-08  
Submission Type: Information Disclosure  
Statement  
Filing Type:  
Confirmation number: 9069  
Attorney Docket Number: 003918P017



RECEIVED  
MAY 20 2003  
TO 2600 FILL ROOM

Total Fees Authorized:

Digital Certificate Holder: cn=William E. Alford, ou=Registered Attorneys, ou=Patent and  
Trademark Office, ou=Department of Commerce, o=U.S. Government, c=US  
Certificate Message Digest: jvm/Uc2CFHybrSh/Aa53w==



# TRANSMITTAL FORM

Electronic Version 1.0.3

Stylesheet Version: 1.0

Submission Type: Information  
Disclosure Statement

Application Number: 09/896695  
Attorney Docket Number: 003918P017

## METHOD AND APPARATUS FOR PUSH BUTTON RELEASE FIBER OPTIC MODULES

First Named Inventor: Liew Chuang Chu

### SUBMITTED BY

Name:

William E. Alford

Registration Number:

37,764

Electronic Signature Mark: /William  
E. Alford/

Date Signed: 20030508

RECEIVED  
MAY 20 2003  
10:20:00 MAIL ROOM

*I certify that the use of this system is for OFFICIAL correspondence between patent applicants or their representatives and the USPTO. Fraudulent or other use besides the filing of official correspondence by authorized parties is strictly prohibited, and subject to a fine and/or imprisonment under applicable law.*

*I, the undersigned, certify that I have viewed a display of document(s) being electronically submitted to the United States Patent and Trademark Office, using either the USPTO provided style sheet or software, and that this is the document(s) I intend for initiation or further prosecution of a patent application noted in the submission. This document(s) will become part of the official electronic record at the USPTO.*

### Attached Files:

us-information-disclosure-statement

E20P017EIDSids.xml

Comments: